



**Pin Definition:**

1. Gate
2. Source
3. Drain

**Key Parameter Performance**

| Parameter          | Value           | Unit |
|--------------------|-----------------|------|
| $V_{DS}$           | 20              | V    |
| $R_{DS(on)}$ (max) | $V_{GS} = 4.5V$ | 33   |
|                    | $V_{GS} = 2.5V$ | 40   |
|                    | $V_{GS} = 1.8V$ | 51   |
| $Q_g$              | 11              | nC   |

**Features**

- Advance Trench Process Technology
- High Density Cell Design for Ultra Low On-resistance

**Application**

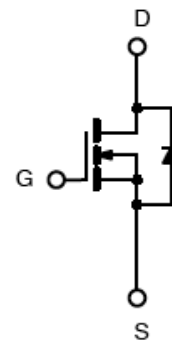
- Load Switch
- PA Switch

**Ordering Information**

| Part No.      | Package | Packing            |
|---------------|---------|--------------------|
| TSM2312CX RFG | SOT-23  | 3,000pcs / 7" Reel |

**Note:** "G" denotes for Halogen- and Antimony-free as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds

**Block Diagram**



N-Channel MOSFET

**Absolute Maximum Ratings** ( $T_C = 25^\circ C$ , unless otherwise noted)

| Parameter  | Symbol         | Limit              | Unit       |
|--|----------------|--------------------|------------|
| Drain-Source Voltage   | $V_{DS}$       | 20                 | V          |
| Gate-Source Voltage  | $V_{GS}$       | $\pm 8$            | V          |
| Continuous Drain Current   | $I_D$          | 4.9                | A          |
| Pulsed Drain Current <sup>(Note 1)</sup>                         | $I_{DM}$       | 15                 | A          |
| Continuous Source Current (Diode Conduction) <sup>(Note 2)</sup> | $I_S$          | 1.0                | A          |
| Maximum Power Dissipation  | $P_D$          | $T_a = 25^\circ C$ | 0.75       |
|  |                | $T_a = 75^\circ C$ | 0.48       |
| Operating Junction and Storage Temperature Range                 | $T_J, T_{STG}$ | -55 to +150        | $^\circ C$ |

**Thermal Performance**

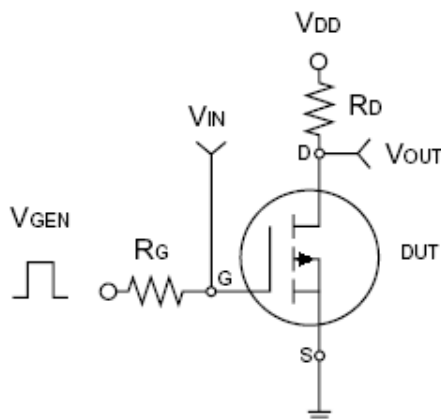
| Parameter                              | Symbol          | Limit | Unit         |
|--|-----------------|-------|--------------|
| Thermal Resistance Junction to Lead    | $R_{\theta JL}$ | 75    | $^\circ C/W$ |
| Thermal Resistance Junction to Ambient | $R_{\theta JA}$ | 140   | $^\circ C/W$ |

### Electrical Specifications

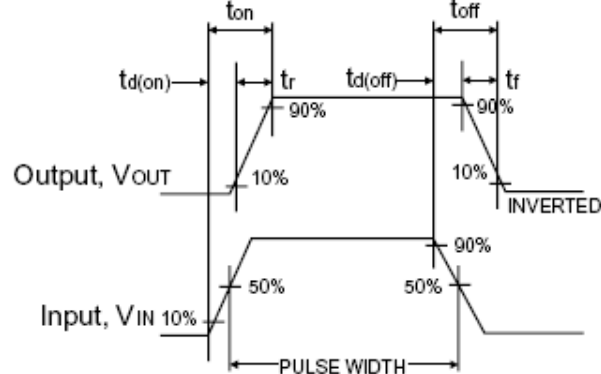
| Parameter                            | Conditions  | Symbol       | Min  | Typ  | Max       | Unit       |
|--------------------------------------|---|--------------|------|------|-----------|------------|
| <b>Static</b> <sup>(Note 3)</sup>    |   |              |      |      |           |            |
| Drain-Source Breakdown Voltage       | $V_{GS} = 0V, I_D = 250\mu A$   | $BV_{DSS}$   | 20   | --   | --        | V          |
| Gate Threshold Voltage               | $V_{DS} = V_{GS}, I_D = 250\mu A$   | $V_{GS(TH)}$ | 0.45 | 0.65 | 1.0       | V          |
| Gate Body Leakage                    | $V_{GS} = \pm 8V, V_{DS} = 0V$  | $I_{GSS}$    | --   | --   | $\pm 100$ | nA         |
| Zero Gate Voltage Drain Current      | $V_{DS} = 16V, V_{GS} = 0V$   | $I_{DSS}$    | --   | --   | 1.0       | $\mu A$    |
| On-State Drain Current               | $V_{DS} = 10V, V_{GS} = 4.5V$   | $I_{D(ON)}$  | 15   | --   | --        | A          |
| Drain-Source On-State Resistance     | $V_{GS} = 4.5V, I_D = 4.9A$   | $R_{DS(ON)}$ | --   | 27   | 33        | m $\Omega$ |
|                                      | $V_{GS} = 2.5V, I_D = 4.4A$   |              | --   | 33   | 40        |            |
|                                      | $V_{GS} = 1.8V, I_D = 3.9A$   |              | --   | 42   | 51        |            |
| Forward Transconductance             | $V_{DS} = 15V, I_D = 5.0A$  | $g_{fs}$     | --   | 40   | --        | S          |
| Diode Forward Voltage                | $I_S = 1.0A, V_{GS} = 0V$   | $V_{SD}$     | --   | 0.8  | 1.2       | V          |
| <b>Dynamic</b> <sup>(Note 4)</sup>   |   |              |      |      |           |            |
| Total Gate Charge                    | $V_{DS} = 10V, I_D = 5.0A,$<br>$V_{GS} = 4.5V$                                    | $Q_g$        | --   | 11   | 14        | nC         |
| Gate-Source Charge                   |   | $Q_{gs}$     | --   | 1.5  | --        |            |
| Gate-Drain Charge                    |   | $Q_{gd}$     | --   | 2.1  | --        |            |
| Input Capacitance                    | $V_{DS} = 10V, V_{GS} = 0V,$<br>$f = 1.0MHz$                                      | $C_{iss}$    | --   | 500  | --        | pF         |
| Output Capacitance                   |   | $C_{oss}$    | --   | 300  | --        |            |
| Reverse Transfer Capacitance         |   | $C_{rss}$    | --   | 140  | --        |            |
| <b>Switching</b> <sup>(Note 5)</sup> |   |              |      |      |           |            |
| Turn-On Delay Time                   | $V_{DD} = 10V, R_L = 10\Omega,$<br>$I_D = 1A, V_{GEN} = 4.5V,$<br>$R_G = 6\Omega$ | $t_{d(on)}$  | --   | 15   | 25        | ns         |
| Turn-On Rise Time                    |   | $t_r$        | --   | 40   | 60        |            |
| Turn-Off Delay Time                  |   | $t_{d(off)}$ | --   | 48   | 70        |            |
| Turn-Off Fall Time                   |   | $t_f$        | --   | 31   | 45        |            |

#### Notes:

1. Pulse width limited by the maximum junction temperature
2. Surface Mounted on FR4 Board  $t \leq 5$  sec.
3. Pulse test:  $PW \leq 300\mu s$ , duty cycle  $\leq 2\%$
4. For DESIGN AID ONLY, not subject to production testing.
5. Switching time is essentially independent of operating temperature.



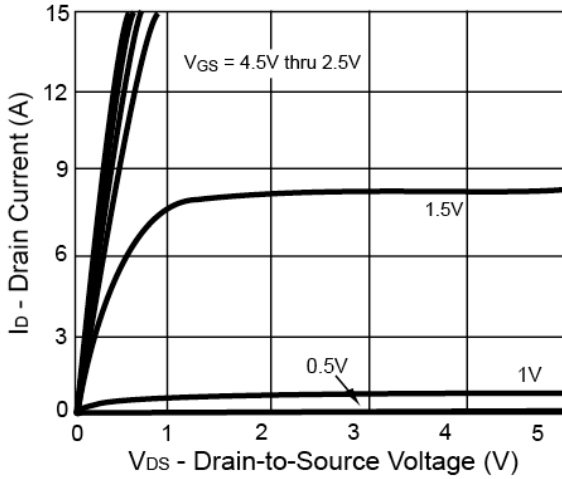
Switching Test Circuit



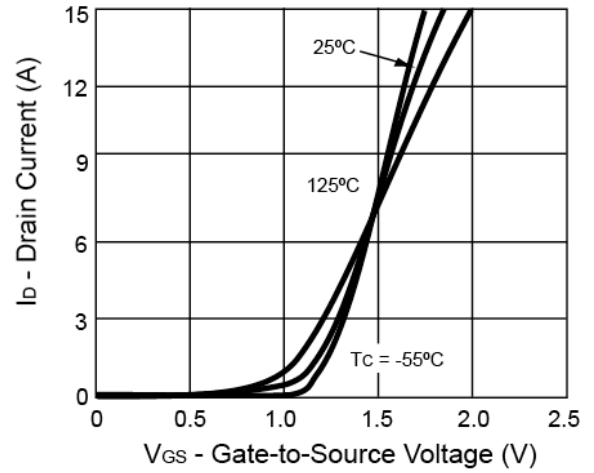
Switchin Waveforms

### Electrical Characteristics Curve

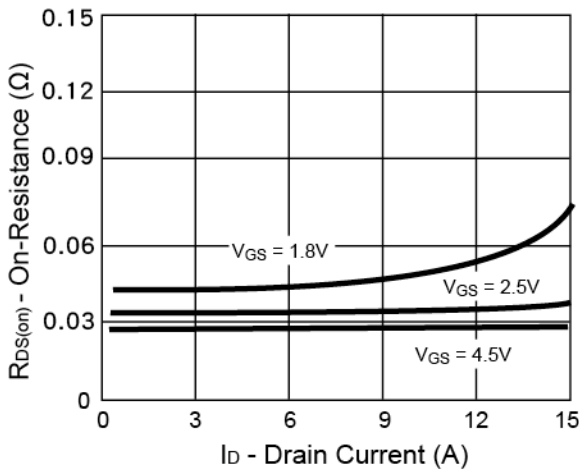
**Output Characteristics**



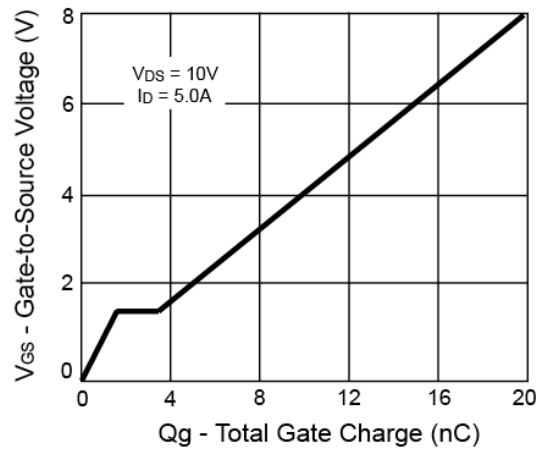
**Transfer Characteristics**



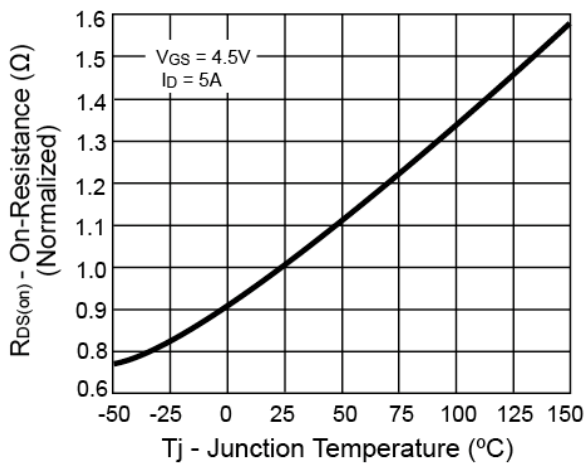
**On-Resistance vs. Drain Current**



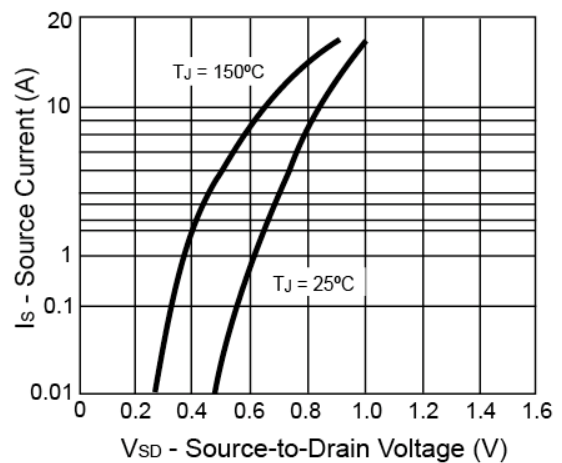
**Gate Charge**



**On-Resistance vs. Junction Temperature**

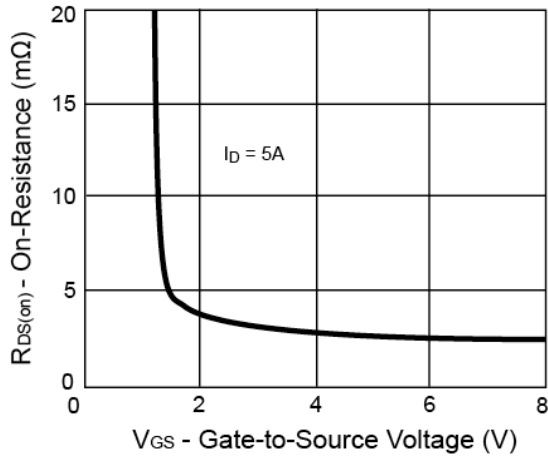


**Source-Drain Diode Forward Voltage**

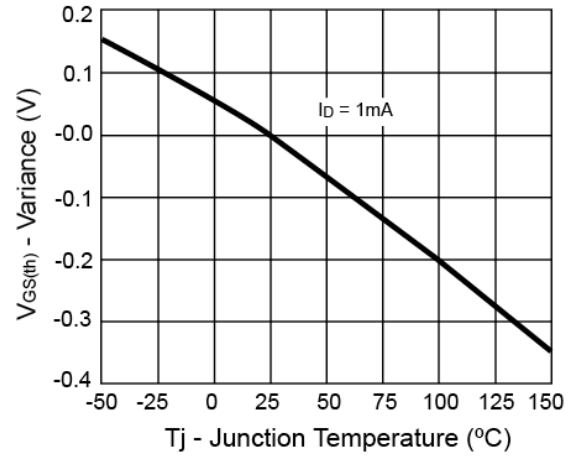


**Electrical Characteristics Curve**

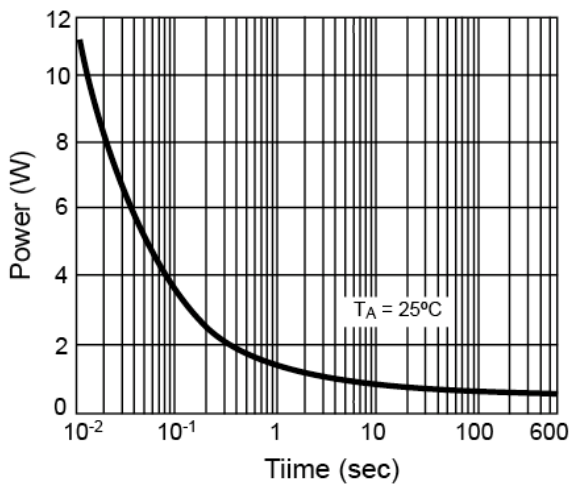
**On-Resistance vs. Gate-Source Voltage**



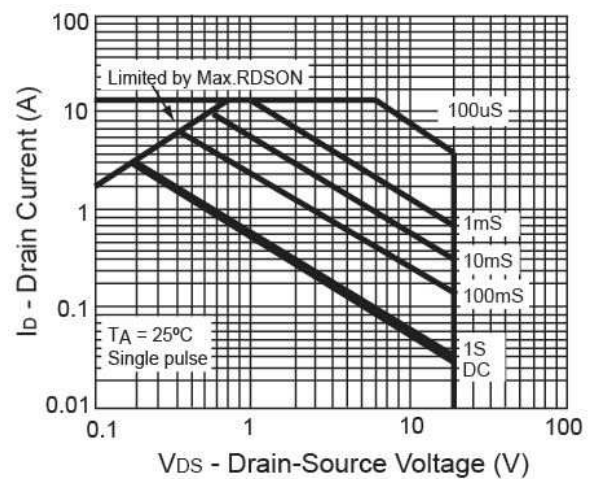
**Threshold Voltage**



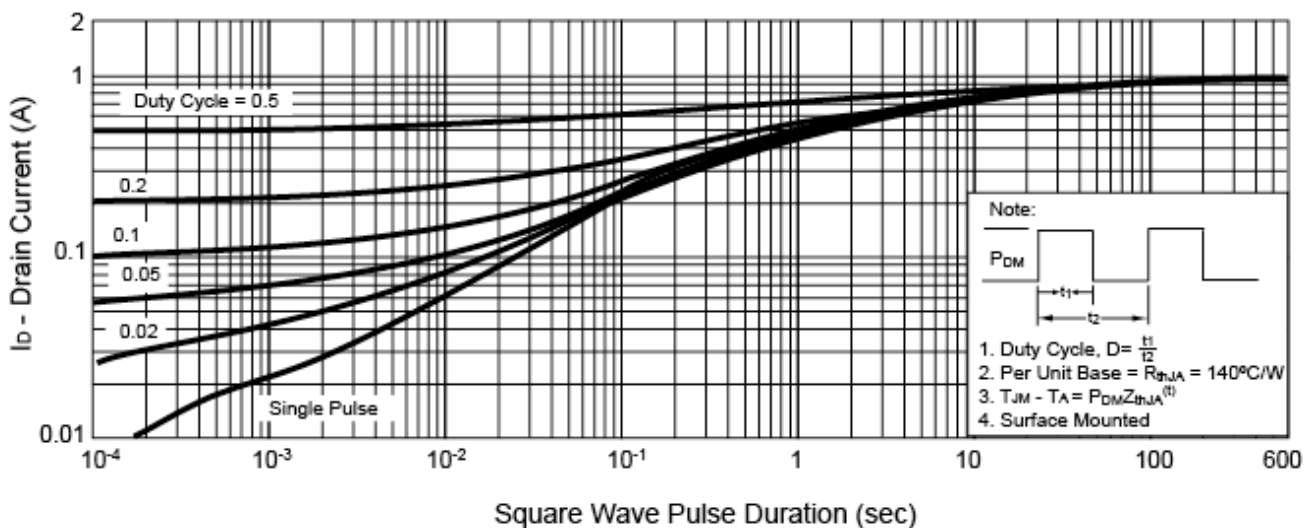
**Single Pulse Power**



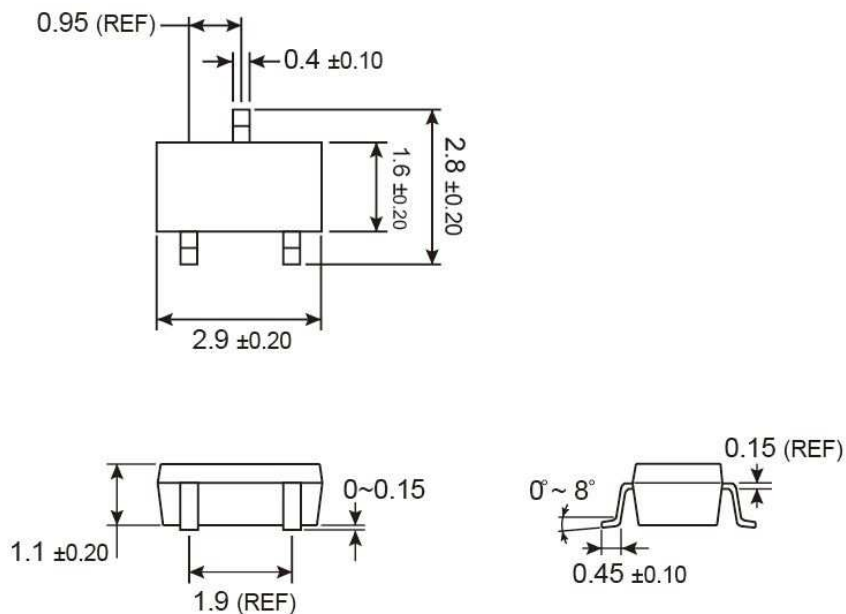
**Safety Operation Area**



**Normalized Thermal Transient Impedance, Junction-to-Ambient**

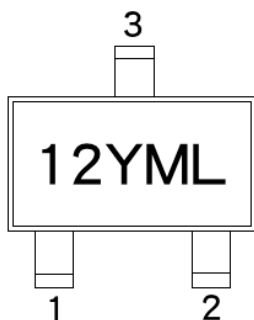


**SOT-23 Mechanical Drawing**



Unit: Millimeters

**Marking Diagram**



- 12** = Device Code
- Y** = Year Code
- M** = Month Code for Halogen Free Product
  - O** =Jan    **P** =Feb    **Q** =Mar    **R** =Apr
  - S** =May    **T** =Jun    **U** =Jul    **V** =Aug
  - W** =Sep    **X** =Oct    **Y** =Nov    **Z** =Dec
- L** = Lot Code

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